<table>
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<tr>
<th>Symbol</th>
<th>Hit Count</th>
<th>Tool Size</th>
<th>Plated</th>
<th>Hole Type</th>
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<td>7</td>
<td>7.62±0.030 (0.300±0.001)</td>
<td>PTH</td>
<td>Round</td>
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<tr>
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<td>14</td>
<td>10.02±0.030 (0.393±0.001)</td>
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<tr>
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<tr>
<td>🌀</td>
<td>11</td>
<td>20.50±0.030 (1.270±0.001)</td>
<td>PTH</td>
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</tr>
</tbody>
</table>

288 Total

**Drill Table**
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